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# Photoelectrocatalytic reduction of carbon dioxide to methanol at cuprous oxide foam cathode

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In order to increase the reduction rate of CO<sub>2</sub> to methanol, the photoelectrocatalytic reduction of CO<sub>2</sub> at Cu<sub>2</sub>O foam electrodes is proposed. The Cu<sub>2</sub>O foam electrodes are fabricated by electrodeposition of Cu<sub>2</sub>O coatings on copper foam substrates. The effect of bath pH and deposition time on the morphology and structure is investigated. The Cu<sub>2</sub>O foam electrodes deposited at bath pH 10 for 20 min exhibit higher intensity of (111) diffraction peak. The photoelectrocatalytic performance of Cu<sub>2</sub>O foam electrodes for CO<sub>2</sub> reduction to methanol depends largely on exposed Cu<sub>2</sub>O{111} facets. At the applied potential of −1.5 V (vs. saturated calomel electrode), the optimum methanol concentration and the faradaic efficiency of methanol formation are obtained within 1.5 h, and they are 1.41 mM and 29.1%, respectively. The formation rate of methanol achieves 23.5 μmol cm<sup>−2</sup> h<sup>−1</sup> within 1.5 h.

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## 1. Introduction

Due to burning of fossil fuel in industrial activities, CO<sub>2</sub> concentration in the atmosphere has been increasing dramatically for decades, causing serious global warming. In order to reduce the emission of CO<sub>2</sub>, such routes as chemical reduction, photochemical reduction, electrochemical reduction, biological reduction, reforming and inorganic conversion have been developed. Among those, photochemical and electrochemical routes are more promising.<sup>1</sup> A lot of semiconductor photocatalysts have been developed for CO<sub>2</sub> reduction, such as Cu-loaded TiO<sub>2</sub>, NiO/InTaO<sub>4</sub> and Ni@NiO core-shell structure-modified nitrogen-doped InTaO<sub>4</sub> semiconductor.<sup>2–4</sup> With the catalysis of Ni@NiO core-shell structure-modified nitrogen-doped InTaO<sub>4</sub> semiconductor, methanol yield is up to 170 μmol g<sup>−1</sup> h<sup>−1</sup>.<sup>4</sup> However, the photocatalytic reduction of CO<sub>2</sub> is usually observed with low yield of methanol and poor selectivity.<sup>1</sup> Electrochemical reduction of CO<sub>2</sub> produces some valuable chemicals, such as CO, formic acid, formaldehyde, methanol, oxalic acid and methane; and the selectivity and yield of CO<sub>2</sub> reduction depends heavily on the catalysts and operation condition.<sup>5–7</sup> CO<sub>2</sub> is electrochemically reduced to methanol at III–V semiconductor (GaAs and InP), Mo and Re electrodes; nevertheless, the rate of methanol formation is low.<sup>8–13</sup> At Cu<sub>2</sub>O electrode

surface, methanol production rate as high as 43 μmol cm<sup>−2</sup> h<sup>−1</sup> and faradaic efficiency up to 38% within 10 min have been reported; however, the activity of Cu<sub>2</sub>O electrode decreases suddenly, and the reduction reaction of CO<sub>2</sub> to methanol stops within 30 min.<sup>14</sup> In order to improve the stability of Cu<sub>2</sub>O electrodes, Cu<sub>2</sub>O/ZnO-based carbon paper electrodes have been fabricated.<sup>15</sup> The electrodes including ZnO are stable after 5 h, but the rate of methanol formation is only 11.41 μmol cm<sup>−2</sup> h<sup>−1</sup>.<sup>15</sup>

Both photochemical and electrochemical routes have low yield of methanol.<sup>1</sup> In photoelectrochemical system, the separation of light-driven electrons and holes in the semiconductor catalysts is promoted, and the reduction and oxidation reaction zones are fully separated; therefore, the yield and selectivity of methanol is enhanced.<sup>1</sup> In addition, compared to electrochemical route, photoelectrochemical route can reduce the consumption of external electric energy.<sup>1</sup> In our previous study, the photoelectrochemical reduction of CO<sub>2</sub> to methanol at p type CuInS<sub>2</sub> thin film photocathode has been proposed, with the overpotential of 20 mV and the faradaic efficiency of 97%;<sup>16</sup> however, due to the mass transfer resistance resulting from pyridine adsorption layer on CuInS<sub>2</sub> electrode, the rate of methanol formation is only 5.9 μmol cm<sup>−2</sup> h<sup>−1</sup>.<sup>17</sup>

Copper foam has large surface area, well-defined pore size and high conductivity, it is therefore a better support for catalysts than conventional planar supports. It is expected to improve the catalytic performance of Cu<sub>2</sub>O for CO<sub>2</sub> reduction by loading Cu<sub>2</sub>O catalysts on copper foam support. In this study, Cu<sub>2</sub>O foam electrodes are fabricated and their photoelectrocatalytic performance for CO<sub>2</sub> reduction to methanol is examined.

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## 2. Experimental

### 2.1. Fabrication of Cu<sub>2</sub>O foam electrodes

Cu<sub>2</sub>O foam electrodes were fabricated by electrodeposition of Cu<sub>2</sub>O coatings on copper foam substrates. A copper foam with the thickness of 0.5 mm was firstly cleaned by sonicating in detergent, acetone and ethanol in turn, then etched in diluted sulphuric acid, and finally cleaned with deionized water. The copper foam (2 cm<sup>2</sup>) was used as the working electrode for electrodeposition. A platinum foil and a saturated calomel electrode (SCE) were used as the counter electrode and reference electrode, respectively. The electrodeposition was carried out by a CHI650D electrochemical workstation (Shanghai Chenhua Instrument Co. Ltd., Shanghai, P. R. China). The electrodeposition bath contained 0.4 mM CuSO<sub>4</sub> and 3 M lactic acid (LA), and was adjusted to pH 9–12 by adding NaOH aqueous solution.<sup>14,18,19</sup> The bath temperature was kept at 60 °C during electrodeposition, and the deposition potential was set to be −0.60 V (*vs.* SCE).

The morphology of Cu<sub>2</sub>O foam electrodes was determined by field emission scanning electron microscopy (FESEM, S-4700, Hitachi, Japan). The crystal structure of thin films was determined by X-ray diffractometry (XRD, Bruker D8 Advance, Germany) using Cu K $\alpha$  radiation ( $\lambda = 1.54056 \text{ \AA}$ ), and the crystal grain size was then calculated from X-ray line broadening using the Scherrer's equation. The UV-vis spectra of Cu<sub>2</sub>O foam electrodes were measured with UV-vis-NIR spectrophotometer (UV-3600, Shimadzu, Japan), and the scanning wavelength was ranged from 400 to 700 nm.

The measurement of Mott–Schottky plot was carried out at 10 kHz in a quartz glass beaker containing 0.1 M KHCO<sub>3</sub> solution by an electrochemistry work station CHI650D. A standard three-electrode arrangement was used with Cu<sub>2</sub>O foam electrodes (2 cm<sup>2</sup>) as the working electrode, graphite sheet as the counter electrode and SCE as the reference electrode. The scanning potential was set from −0.25 to 0.40 V (*vs.* SCE). The visible light irradiation was emitted from xenon lamp (AULTT, Beijing, P. R. China) with the irradiation intensity of 100 mW cm<sup>−2</sup> on the surface of the thin film electrode. In Mott–Schottky plot, the extrapolated linear portion where the line crosses the *x*-axis could be used to calculate the flat band potential by the formula

$$C^{-2} = (2/e\epsilon_0\epsilon A^2 N_A)(E - E_{fb} - K/t) \quad (1)$$

where *C* is the interfacial capacitance, *e* is electron charge,  $\epsilon_0$  is vacuum dielectric constant,  $\epsilon$  is dielectric constant, *A* is the surface area of the working electrode, *N<sub>A</sub>* is doping concentration of the semiconductor, *E* is the applied potential, *E<sub>fb</sub>* is the flat band potential, *K* is Boltzman's constant, and *t* is the absolute temperature.

### 2.2. Photoelectrocatalytic reduction of CO<sub>2</sub>

CO<sub>2</sub> reduction experiments were performed in a quartz glass beaker by electrochemistry work station CHI650D. A conventional three-electrode cell was used with Cu<sub>2</sub>O foam electrode (2 cm<sup>2</sup>) as the working electrode, graphite sheet as the counter

electrode and SCE as the reference electrode. The irradiation intensity on the working electrode was calibrated to be 100 mW cm<sup>−2</sup>.

The electrolyte solution used for the photoelectrocatalytic reduction of CO<sub>2</sub> was 0.1 M KHCO<sub>3</sub> solution (50 mL). All experiments were performed at 25 °C and ambient pressure. Prior to the reduction experiment, the electrolyte solution was saturated with CO<sub>2</sub> gas (99.99%) by bubbling for 30 min. CO<sub>2</sub> gas was continuously aerated at a flow rate of 60 mL min<sup>−1</sup> during the electrolysis process. The faradaic efficiency for producing methanol was calculated assuming six electrons are required per methanol molecule.

Liquid product analysis was accomplished using gas chromatography-mass spectroscopy (GC-MS, Trace 1300-ISQ, ThermoFisher Scientific, USA). Methanol concentration was measured by a gas chromatography (GC 2014C, Shimadzu, Japan) with a DB-Wax (30 m × 0.53 mm × 3.00  $\mu$ m, Agilent Technologies). The injector temperature was held at 200 °C, the oven temperature rose from 50 to 200 °C at the rate of 5 °C min<sup>−1</sup>, and the detector temperature was kept at 230 °C. Five runs were done for one experiment.

## 3. Results and discussion

### 3.1. Fabrication of Cu<sub>2</sub>O foam electrodes by electrodeposition

At bath pH 9–12, Cu<sub>2</sub>O coatings on copper foam substrate can be obtained from a lactate-stabilized CuSO<sub>4</sub> solution. The FESEM images of Cu<sub>2</sub>O foam electrodes electrodeposited at bath pH 10 for 30 min are shown in Fig. 1.

It can be observed that the Cu<sub>2</sub>O foam electrode has three-dimensional network structure (Fig. 1a), and copper foam substrate is covered with a 4  $\mu$ m-thick-coating (Fig. 1b); in addition, the coaxial structure of outer Cu<sub>2</sub>O coatings and inner copper wire forms (Fig. 1b). Compared to the conventional planar electrode, the three-dimensional network structure of the Cu<sub>2</sub>O foam electrode provides much high specific surface area, which promotes the full contact of the catalytic active centers with the reactants in CO<sub>2</sub> reduction. Additionally, the coaxial structure of the Cu<sub>2</sub>O foam electrode promotes the charge transfer between Cu<sub>2</sub>O crystal grains and copper wires.

The electrodeposition bath pH has a significant influence on the morphology of Cu<sub>2</sub>O coatings as shown in Fig. 2. The surface of Cu<sub>2</sub>O coatings deposited at bath pH 9 and 10 exhibits pyramid and truncated pyramid geometry, respectively. At bath

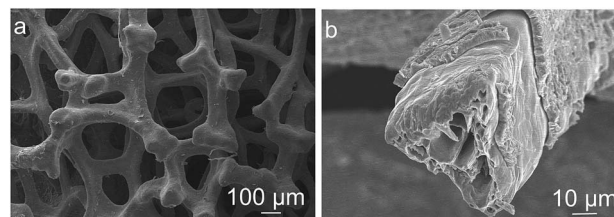


Fig. 1 FESEM images of the Cu<sub>2</sub>O foam electrodes. (a) Full view, (b) cross section view.



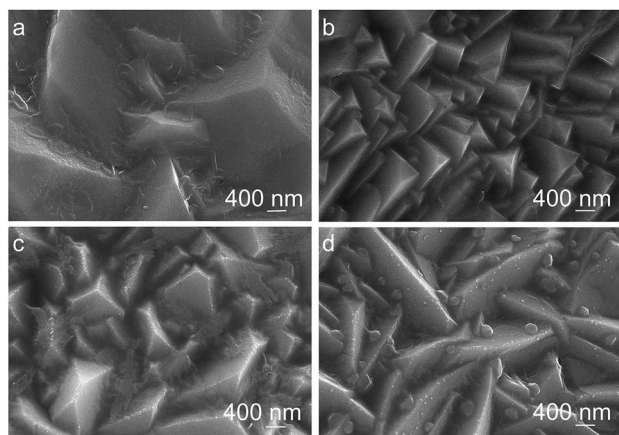


Fig. 2 FESEM image of  $\text{Cu}_2\text{O}$  coatings electrodeposited at various bath pH. (a) pH = 9, (b) pH = 10, (c) pH = 11, (d) pH = 12.

pH over 11, the surface of  $\text{Cu}_2\text{O}$  coatings shows prism geometry, and the  $\text{Cu}_2\text{O}$  particles become large as pH increases.

The XRD patterns of  $\text{Cu}_2\text{O}$  foam electrodes deposited at various bath pH are investigated (Fig. 3). The peaks at  $43.4^\circ$ ,  $50.5^\circ$  and  $74.1^\circ$  can be indexed to  $\text{Cu}(111)$ , (200) and (222) facets; the peaks at  $29.8^\circ$ ,  $37.4^\circ$ ,  $50.8^\circ$  and  $61.8^\circ$  can be indexed to cuprite  $\text{Cu}_2\text{O}(110)$ , (111), (200) and (220) facets, and a very strong peak at  $37.4^\circ$  indicates the preferential growth along (111) facet.

At lower bath pH (<7), due to the reduction of  $\text{Cu}_2\text{O}$ , metallic Cu may occur (eqn (2)).<sup>18,19</sup>



However, at higher bath pH and lower deposition potential (below  $-0.6$  V vs. SCE), the reduction of  $\text{Cu}_2\text{O}$  is forbidden.<sup>18,19</sup> Since all deposition experiments have been carried out at higher bath pH in this study, there is less possibility to form metallic Cu in the electrodeposition of  $\text{Cu}_2\text{O}$  coatings. In order to verify that no metallic Cu produces in the electrodeposition,  $\text{Cu}_2\text{O}$

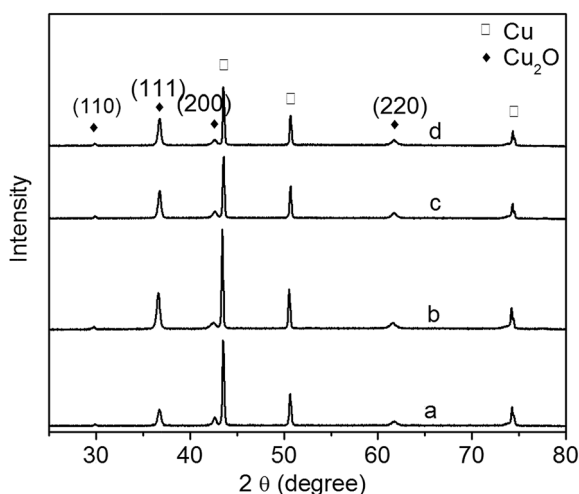


Fig. 3 XRD patterns of  $\text{Cu}_2\text{O}$  foam electrodes from electrodeposition solution of various bath pH. (a) pH = 9, (b) pH = 10, (c) pH = 11, (d) pH = 12.

thin films have been electrodeposited on indium tin oxide conductive glass instead of copper foam substrate, and no diffraction peaks of metallic Cu are detected for the thin films. Therefore the diffraction peaks of metallic Cu are resulted from copper foam substrate.

It has been reported that the preferential facet depends on bath pH: the preferential facet is (200) facet at pH below 9, while it becomes (111) facet at pH above 9.<sup>20</sup> In the present study, due to the higher pH, all of the samples have the preferential facet of (111). There are two forms of  $\text{Cu}(\text{II})$ ,  $[\text{Cu}(\text{OH})_n]^{2-n}$  and  $[\text{Cu}(\text{LA})_n]^{2-n}$ , existing in a basic solution:  $[\text{Cu}(\text{LA})_n]^{2-n}$  dominates at lower pH, and  $[\text{Cu}(\text{OH})_n]^{2-n}$  dominates at higher pH.<sup>21</sup> It is therefore concluded that  $[\text{Cu}(\text{OH})_n]^{2-n}$  promotes the crystal growth along (111) facet.

The diffraction peak intensity of  $\text{Cu}_2\text{O}(111)$  facet is bath pH dependent (Fig. 3). The peak becomes strong when pH goes up from 9 to 10, indicating that more {111} facets exposed on the surface are formed;<sup>22</sup> however, it becomes weak gradually at pH above 10. The relationship of  $\text{Cu}_2\text{O}$  grain size to bath pH is shown in Table 1. The grain size varies between 24 and 28 nm, and it becomes large as pH increases. This is because grain size is related to the preferred orientation, and the preferred orientation is pH dependent.<sup>20,23</sup>

Fig. 4 shows the UV-vis spectra and bandgap (inset) of  $\text{Cu}_2\text{O}$  foam electrodes deposited at various bath pH. All of  $\text{Cu}_2\text{O}$  foam electrodes exhibit strong absorbance in the visible light range, especially in 400–550 nm range. Roughly speaking, the

Table 1 Relationship of  $\text{Cu}_2\text{O}$  grain size to deposition bath pH

Bath pH	Grain size (nm)
9	24.82
10	26.46
11	26.87
12	27.47

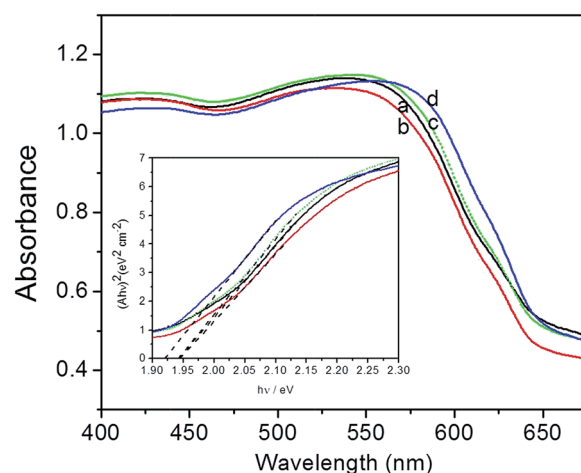


Fig. 4 UV-vis spectra and bandgap (inset) of  $\text{Cu}_2\text{O}$  foam electrodes from various bath pH. (a) pH = 9, (b) pH = 10, (c) pH = 11, (d) pH = 12.



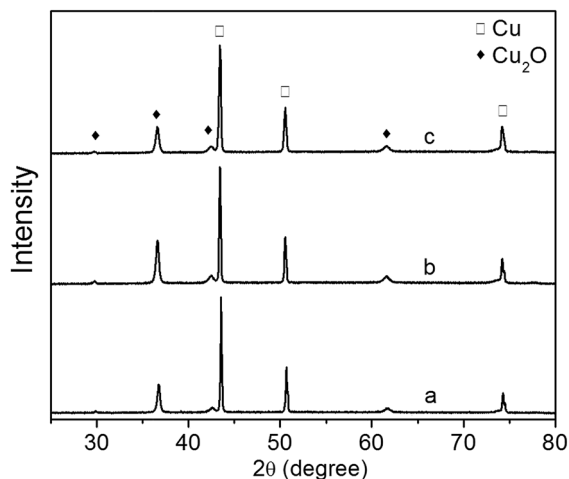


Fig. 5 XRD patterns of Cu<sub>2</sub>O foam electrodes electrodeposited at various deposition time. (a) 10 min, (b) 20 min, (c) 30 min.

absorbance edge and the bandgap (1.94–1.92 eV) remains unchanged as bath pH increases.

The XRD patterns of Cu<sub>2</sub>O foam electrodes electrodeposited at various deposition time are shown in Fig. 5. All samples show the preferential growth along (111) facet. Compared to the samples deposited for 10 and 30 min, the sample deposited for 20 min exhibits the stronger diffraction peak of Cu<sub>2</sub>O(111) facet, indicating that more {111} facets exposed on the surface are formed.<sup>22</sup> The grain size of Cu<sub>2</sub>O coatings increases from 25.48 nm for 10 min to 26.89 nm for 30 min.

Mott–Schottly plot of Cu<sub>2</sub>O foam electrode electrodeposited for 20 min at bath pH 10 is shown in Fig. 6. The flat band potential is calculated to be 0.05 V (*vs.* SCE). In addition, the slope of the linear portion is associated with the conductivity type of the Cu<sub>2</sub>O coatings. The negative slope indicates that the conductivity of the Cu<sub>2</sub>O coatings is p-type. For p-type semiconductors, the flatband potential is roughly equal to its valence band potential; therefore, the potentials of conduction band

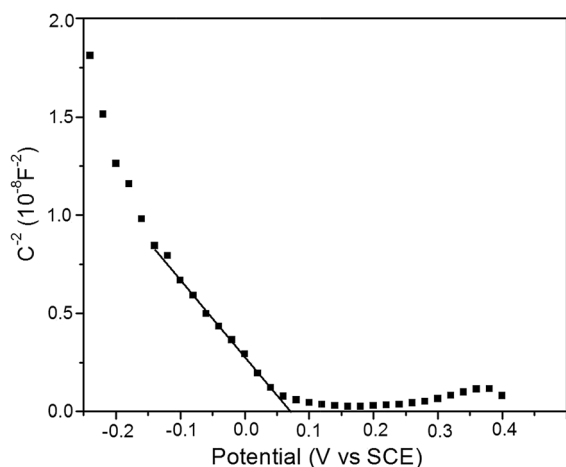


Fig. 6 Mott–Schottly plot of Cu<sub>2</sub>O foam electrode electrodeposited for 20 min at pH 10.

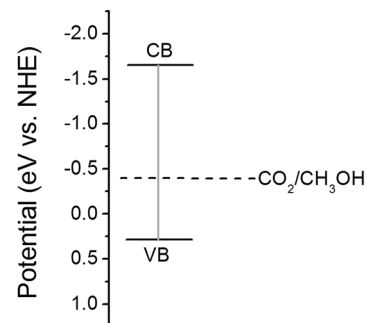


Fig. 7 Band structure in Cu<sub>2</sub>O coatings.

and valence band are calculated to be  $-1.64$  and  $0.29$  eV (*vs.* normal hydrogen electrode, NHE), respectively. The band structure in Cu<sub>2</sub>O coatings is schemed in Fig. 7. Since the conduction band potential of Cu<sub>2</sub>O coatings is more negative than the reduction potential of CO<sub>2</sub> to methanol, Cu<sub>2</sub>O coatings

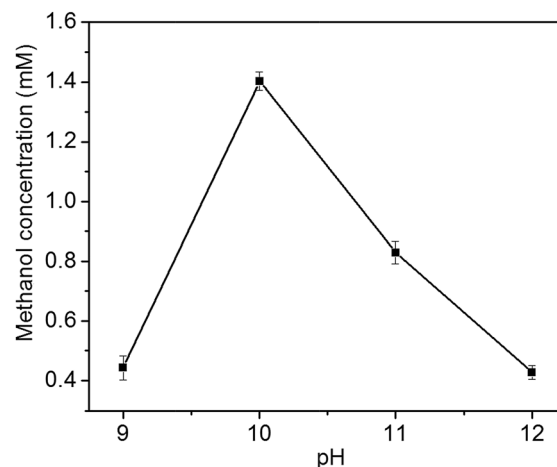


Fig. 8 Effect of bath pH on methanol concentration.

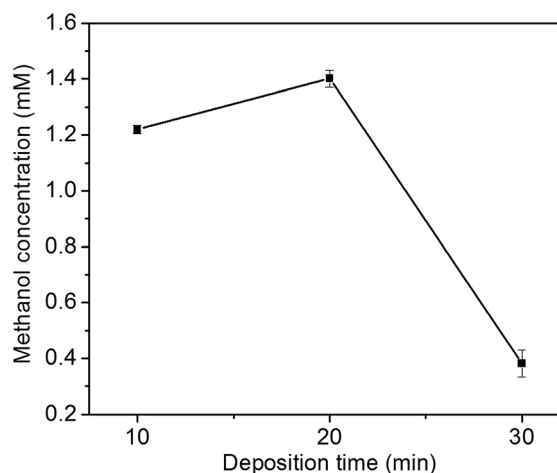


Fig. 9 Effect of Cu<sub>2</sub>O foam electrodes electrodeposited for various deposition time on methanol concentration.



should have the photocatalytic ability for reducing  $\text{CO}_2$  to methanol.

### 3.2. Photoelectrocatalytic reduction of $\text{CO}_2$

In the liquid product of photoelectrocatalytic reduction of  $\text{CO}_2$ , only methanol is detected by GC-MS in this study. In contrast, ethanol, formic acid, formaldehyde, propanol, acetic acid and methanol is obtained at  $\text{Cu}_2\text{O}$  cathode by Yadav *et al.*<sup>24</sup> The different products might be resulted from the different preferential growth facets of  $\text{Cu}_2\text{O}$  electrode: methanol is the major product at  $\text{Cu}_2\text{O}\{111\}$  facet, while ethanol is the major product at  $\text{Cu}_2\text{O}\{100\}$  facet.<sup>24</sup>

The photoelectrocatalytic performance of  $\text{Cu}_2\text{O}$  foam electrodes is dependent on electrodeposition bath pH (Fig. 8). Methanol concentration increases with bath pH from 9 to 10, and reach a maximum at bath pH 10, then decreases with bath pH from 10 to 12. The behaviour of photoelectrocatalytic performance over bath pH is similar to that of  $\text{Cu}_2\text{O}(111)$  peak intensity over bath pH (Fig. 3), indicating that the

photoelectrocatalytic performance of  $\text{Cu}_2\text{O}$  foam electrodes depends largely on exposed  $\text{Cu}_2\text{O}\{111\}$  facets. It has been suggested that  $\text{Cu}_2\text{O}$  can stabilize reaction intermediates of  $\text{CO}_2$  reduction, methoxy adsorbates ( $\text{H}_3\text{CO}^-$ ), and the unsaturated oxygen atoms at  $\text{Cu}_2\text{O}\{111\}$  facets act as hydrogen donor sites in  $\text{CO}_2$  reduction,<sup>25,26</sup> then  $\text{Cu}_2\text{O}\{111\}$  facets favour hydrogen addition to the oxygen atom of  $\text{H}_3\text{CO}^-$  adsorbate rather than carbon atom;<sup>14</sup> therefore, methanol is formed.

The effect of  $\text{Cu}_2\text{O}$  foam electrodes deposited for various deposition time on methanol concentration is shown in Fig. 9. Compared to those deposited for 10 and 30 min,  $\text{Cu}_2\text{O}$  foam electrodes deposited for 20 min gives the optimum methanol concentration (1.41 mM) within 1.5 h. It might be associated with more exposed  $\text{Cu}_2\text{O}\{111\}$  facets for the electrode deposited for 20 min (Fig. 5).

The relationship of methanol concentration to the applied potential is presented in Fig. 10a. Methanol concentration increases from 0.26 to 1.41 mM with the increase of the applied potential from  $-1.1$  to  $-1.5$  V, then decreases with the increase of the applied potential from  $-1.5$  to  $-1.7$  V. The faradaic

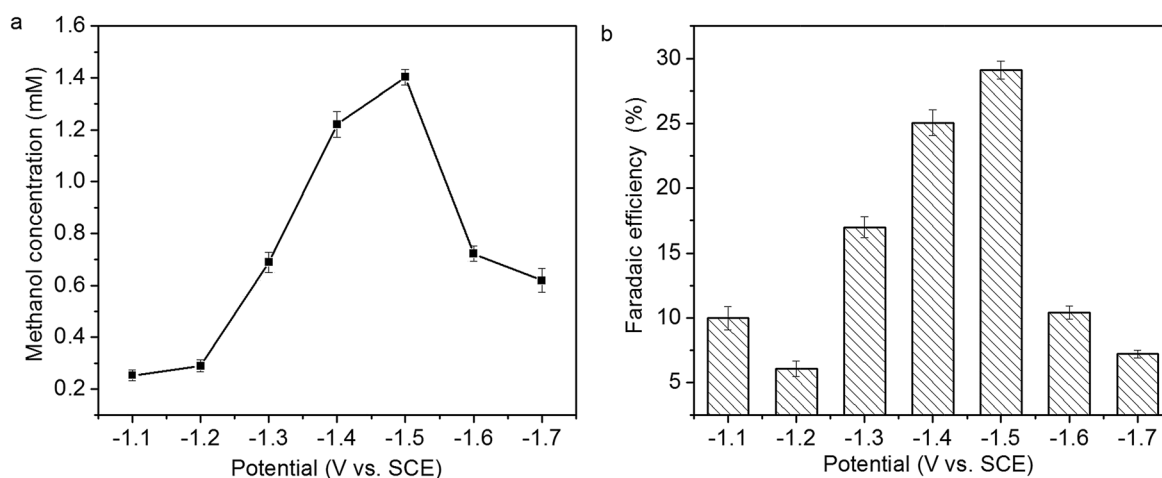


Fig. 10 Relationship of (a) methanol concentration and (b) faradaic efficiency of methanol formation to the applied potential.

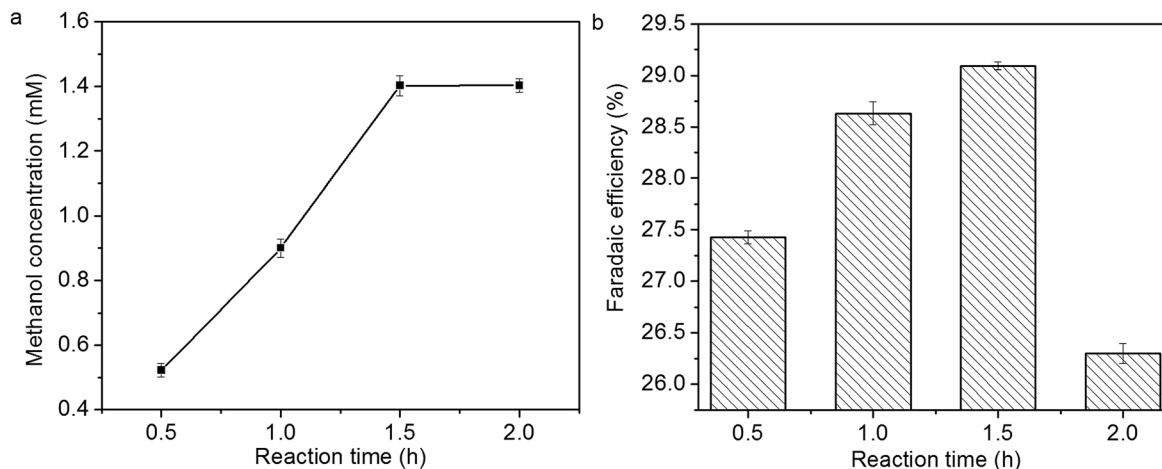


Fig. 11 Influence of reaction time on (a) methanol concentration and (b) faradaic efficiency of methanol formation.



efficiency of methanol formation at various applied potential is presented in Fig. 10b. The highest faradaic efficiency, 29.1%, is achieved at  $-1.5$  V. In addition to methanol, hydrogen gas and CO are also formed in  $\text{CO}_2$  reduction. The decrease of methanol concentration and faradaic efficiency of methanol formation at higher applied potential might be attributed to hydrogen evolution reaction and/or  $\text{Cu}_2\text{O}$  reduction.<sup>14,15</sup>

The influence of reaction time on methanol concentration and faradaic efficiency of methanol formation is shown in Fig. 11a and b. Methanol concentration increases linearly within 1.5 h, then it levels off. The faradaic efficiency of methanol formation also increases within 1.5 h; however, it decreases over 1.5 h, which might be due to the deactivation of  $\text{Cu}_2\text{O}$  coatings.<sup>14,15</sup>

In previous study, the activity of  $\text{Cu}_2\text{O}$  electrodes derived from electrodeposition and air oxidation decreases suddenly, and methanol formation diminishes over 30 min.<sup>14</sup> In this study, the stability of  $\text{Cu}_2\text{O}$  foam electrodes are improved, and a high formation rate of methanol ( $23.5 \mu\text{mol cm}^{-2} \text{h}^{-1}$ ) can be obtained within 1.5 h.

The morphology of  $\text{Cu}_2\text{O}$  foam electrode surface during photoelectrocatalytic reaction is examined as shown in Fig. 12. Compared to the as-prepared foam electrode, the electrode surface becomes rough and many fine particles occur after

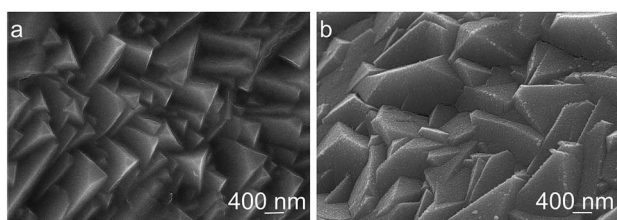


Fig. 12 Morphology of  $\text{Cu}_2\text{O}$  foam electrodes surface during photoelectrocatalytic reaction. (a) Before reaction, (b) after reaction for 1.5 h.

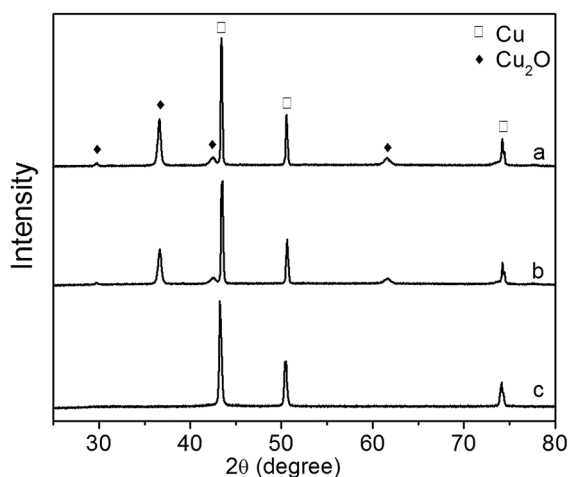


Fig. 13 XRD patterns of  $\text{Cu}_2\text{O}$  foam electrodes during photoelectrocatalytic reaction. (a) Before reaction, (b) after reaction for 0.5 h, (c) after reaction for 1.5 h.

photoelectrocatalytic reaction, and the fine particles become large with reaction time.

The XRD patterns of  $\text{Cu}_2\text{O}$  foam electrodes before and after photoelectrocatalytic reaction are presented in Fig. 13. The  $\text{Cu}_2\text{O}(111)$  peak becomes weak at 0.5 h, and disappears at 1.5 h, indicating that  $\text{Cu}_2\text{O}$  is gradually reduced during photoelectrocatalytic reaction.

## 4. Conclusions

The  $\text{Cu}_2\text{O}$  foam electrodes have been fabricated by electrodeposition of  $\text{Cu}_2\text{O}$  coatings on copper foam substrate. They have three-dimensional coaxial structure. At bath pH 9–12, cuprite  $\text{Cu}_2\text{O}$  coatings can be obtained with (111) facet as the preferential growth facet, and  $\text{Cu}_2\text{O}$  grain become larger with increasing pH. All of  $\text{Cu}_2\text{O}$  foam electrodes exhibit strong absorbance in the visible light range, especially in 400–550 nm range. The resulted  $\text{Cu}_2\text{O}$  foam electrodes show photoelectrocatalytic performance on the reduction of  $\text{CO}_2$  to methanol. The  $\text{Cu}_2\text{O}$  foam electrodes deposited at bath pH 10 for 20 min have higher intensity of (111) diffraction peak, and exhibit higher catalytic activity, indicating that photoelectrocatalytic performance of  $\text{Cu}_2\text{O}$  foam electrodes depends largely on exposed  $\text{Cu}_2\text{O}\{111\}$  facets. At the applied potential of  $-1.5$  V (vs. SCE), the optimum methanol concentration and the faradaic efficiency of methanol formation are obtained within 1.5 h, and they are 1.41 mM and 29.1%, respectively. The formation rate of methanol achieves  $23.5 \mu\text{mol cm}^{-2} \text{h}^{-1}$  within 1.5 h. The gradual reduction of  $\text{Cu}_2\text{O}$  leads to the deactivation of  $\text{Cu}_2\text{O}$  foam electrodes.

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